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Thermal transfer simulation regarding the rotational moulding of polyamide 11

Said Lotfi Hafsaoui · Mokhtar Benziane ·
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Abstract Simulation of thermal phenomena in rotational moulding is very important to follow the evolution of the temperature in various zones of this process. It was a question of modelling heat gradients developing in rotational moulding part. Thermal model tested take into account the temperature change (thermal transfer mechanism) of melting and crystallization pseudo-stages (enthalpy method). Series of tests in polyamide 11 (PA11) were carried out by means of rotational moulding STP LAB, and non-isothermal crystallization kinetics of rotational moulding PA11 grade are measured and analysed by DSC technique type TAQ20. A result of non-isothermal crystallization of the studied polyamide was confronted with Ozawa model. In order to test the validity degree of enthalpy method (layer to layer), another approach based on Ozawa model has also been used in the case of cooling pseudo-stage. As results, the rotational moulding of PA11 was successfully carried out. The simulation of the fusion and crystallization stages, by application of Ozawa model coupled with enthalpy method gave a good representation of experimental data.

Keywords Rotational moulding · Polyamide 11 · Thermal simulation · Ozawa model · Enthalpy method

Introduction

Nowadays, rotational moulding polymer process is considered as the fastest growing sector of the plastics processing industry [1]. It is an economical manufacturing method for producing large or small, stress-free, one piece, and hollow plastic articles [2–6]. Rotational moulding differs from all conventional processing methods especially in heating, and cooling stages which are occurring after the polymer is placed in the mould, and no external pressure is applied.

The development of this process is possible by considering the manufacture of technical parts, satisfying requirements of many sectors like automotive, civil engineering, sport and leisure. In certain applications, rotational moulding becomes an interesting alternative to stretch blow moulding [7, 8]. Many research works were launched to better including, understanding and optimising the various stages of transformation [9–13].

The principal disadvantage of rotational moulding, compared to conventional techniques, is the relatively long cycle time. Polymer is carried during several tens of minutes in a molten state at high temperature with the presence of air. Therefore, the polymer material can be affected by the thermal degradation risk.

This paper is devoted to the study of thermal model predicting temperature variation at any point of the polymer part in development stages.

Thermal simulation of heat phenomena in rotational moulding must pass by a better comprehension of complex mechanisms which govern various stages of transformation.

However, in this process, study of these mechanisms is very difficult, because in reality, temperature is not constant and is characterised by certain heterogeneity. In rotational moulding, thermal cycle is schematically composed of two

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stages: a heating stage followed by a cooling. These stages do not occur at constant rate, and each one comprise a pseudo-stage generated by a phase changes corresponding to fusion and crystallization.

This study is divided into two main parts, the first one is focused on the rotational moulding of polyamide 11, and the second one is devoted to simulation of thermal transfer phenomenon in rotational moulding and modelling of phase changes by enthalpy method [14–16] coupled to Ozawa model [17]. The results obtained allow us to validate the theoretical approach adopted by the experimentation and to observe that the two shutters (theoretical and experimental) are closely dependant.

Experimental

Materials and preparation

The polymer under study, supplied by Akrema INC, is an aliphatic Polyamide (PA11) as powder. For the reason of the hydrophilic character of this polyamide, all samples were dried in a vacuum oven at 80 °C for 8 h before use. Curve obtained by differential scanning calorimetry (under N₂ at 10 °C min⁻¹) gives a melting point T_f at 186 °C, a crystallization temperature T_C at 162 °C, a melting enthalpy H_m of 49 J g⁻¹ and a crystallization enthalpy H_C of 38 J g⁻¹.

Method

Rotational moulding and correcttemp measurement

A spherical PA11 parts of 2-mm thickness was processed in an aluminium mould of 5-mm thickness and inner diameter of 78 mm, with a rotational moulding machine shuttle STP LAB40 equipped by an electrical furnace maintained at a constant temperature of 350 °C. Corresponding processing conditions are given in Table 1.

During the processing operations, the internal air temperature T_a was measured in the centre of the mould with a temperature sensor (CorrectTemp). The average rate was about 10 °C min⁻¹ for heating stage and about 20 °C min⁻¹ for cooling stage.

Differential scanning calorimetry measurements

Thermal analysis of the samples was performed using a DSC TAQ20. All tests were performed under nitrogen

atmosphere with a sample mass range between 5 and 8 mg. All samples were heated quickly to 220 °C, above the melting temperature at a rate of 10 °C min⁻¹ and kept for 10 min to eliminate prior thermal history. Then, the sample was cooled down to ambient temperature at various cooling rate: 5, 7, 10, 12, 15, 18 and 20 °C min⁻¹. The exothermic curves of heat flow were recorded and investigated.

Results and discussion

Temperature measurement during rotational moulding

By following the temperature variation inside the mould as shown on the Fig. 1, we could differentiate six principal stages:

- Up to point *a*, mould and polymer is still cold, the polymer has not yet reached its melting point (the powder form is maintained). Once the heat passes (from oven) through mould into its interior part, the internal temperature increases at constant rate.
- At point *a*, the polymer melting point is reached into the interior part of the mould. A first grain powder adheres to mould and the heating rate decreases, due to insulating character of polymer.
- At point *b*, all grains powder is melted and the temperature increases quickly. A maximum temperature is selected to give a time and sufficient fluidity to polymer for a homogeneous distribution. The choice of this temperature is important to avoid polymer thermal degradation. In this study, we cannot exceed the maximum temperature of 280 °C, temperature beyond which the risks of thermolysis of hydrocarbon polymers become significant [6, 7, 18, 19]. As an example, a maximum temperature of internal air was 245 °C for a 20 min heating time and 275 °C for a 30 min heating time, in both cases with oven maintained at 350 °C.
- At point *c*, heating is stopped. Mould in rotation leaves oven to enter in cooling room. Temperature decreases linearly up to point *d*.
- At point *d*, polymer begins its solidification. Cooling rate decreases under crystallization exothermic effect and finishes at point *e*, where the molecular movements become very slow and the end of crystallization is reached.
- At point *f*, part is unmoulded.

Table 1 Rotational moulding operating conditions

Heating time/min	Cooling time/min	Rotational speed around axis 1/rpm	Rotational speed around axis 2/rpm
30	20	9.6	4

Fig. 1 Temperature versus time, (T/t) diagram of PA 11. Various points indicate: (a) fusion of ‘elementary’ layer of polymer powder in contact with mould internal surface; (b) fusion of ‘elementary’ layer furthest away from mould surface; (c) end of heating and cooling beginning; (d–e) polymer crystallization; (f) end of rotational moulding

Non-isothermal crystallization behaviour

Figure 2 shows typical non-isothermal crystallization curves of PA11 for different cooling rates.

These results are recapitulated in Table 2 in which the following parameters are determined:

- Onset temperature of crystallization T_0 , crystallization temperatures (the exothermic peak maxima) T_p ,

Fig. 2 DSC curves of non-isothermal crystallization at different cooling rates of PA11

Table 2 Values of ΔH_C , T_0 , T_p and t_p at various cooling rates for rotational moulding PA6 grade

$\phi/^\circ\text{C min}^{-1}$	$\Delta H_C/\text{J g}^{-1}$	$T_0/^\circ\text{C}$	$T_p/^\circ\text{C}$	T_p/min
5	39.45	171.44	167.15	0.86
7	39.21	168.04	162.59	0.78
10	38.79	163.38	156.95	0.64
12	38.64	157.41	150.79	0.55
15	38.22	151.58	144.27	0.48
18	38.01	148.56	141.14	0.41
20	37.95	145.18	137.29	0.39

crystallization enthalpy ΔH_C , crystallization peak time t_p , interval time between T_0 and T_p .

These results call the following comments:

- T_0 and T_p decrease by increasing cooling rate.
- The peak is widened when the cooling rate is more important.
- The crystallization rate depends on the cooling rate that means ΔH_C is inversely proportional to the cooling rate.

Ozawa version analysis

From results depicted on Fig. 2, we can follow the relative degree of crystallinity, X_T , as a function of temperature using the following equation:

$$X_T = \frac{\int_{T_0}^T (dH_C/dT)dT}{\int_{T_0}^{T_\infty} (dH_C/dT)dT}, \quad (1)$$

where, dH_C/dT is the heat flow rate. T_0 and T_∞ are the temperatures at which crystallization starts and finishes. Figure 3 shows the relative degree of crystallinity versus the temperature.

Ozawa proposed a theory [17] to calculate crystallinity rate, X_t , in the case of non-isothermal crystallization. The assumption lies on the fact that the relationship between growth rate and activation frequency of nucleation is constant during crystallization. This theory makes it possible to arrive at noted general expression:

$$\log[-\ln(1 - X_t)] = \log K(T) - m \log \phi, \quad (2)$$

where, m is the index of Ozawa similar to Avrami exponent, ϕ is the cooling rate and $K(T)$ is the function of cooling rate.

The results obtained from non-isothermal crystallization of the studied polyamide are compared to Ozawa’s model which allows quantifying by means of the Avrami coefficient (factor m), the type of nucleation (homogeneous or heterogeneous) and the geometry of growth.

Fig. 3 Relative crystallinity versus temperature for non-isothermal crystallization of PA11

Figure 4 illustrates the plots of $\log[\ln(1 - X_T)]$ as a function of $\log \phi$.

A series of straight lines are obtained meaning that the Ozawa's model is appropriate for describing the non-isothermal crystallization kinetics in this kind of temperature range. Parameters m and $K(T)$ can be obtained from the slope and the intercept of the line.

The m and $\log K(T)$ at different temperatures are listed in Table 3.

We can thus evaluate the complexity of the mechanism of crystallization [20], because an intermediate situation is obtained between instantaneous nucleation ($m = 2$) and sporadic nucleation ($m = 3$), with two-dimensional crystallization geometry growth.

Fig. 4 Plots of $\log[-\ln(1 - X_T)]$ versus $\log \phi$, for PA11

Table 3 Non-isothermal crystallization parameters obtained by Ozawa method

$T_0/^\circ\text{C}$	m	$k(T)/\text{K min}^{-m}$	R
155.75	3.71	427.74	0.9999
154.55	3.41	638.52	0.9998
153.66	3.38	694.13	0.9997
151.26	3.13	1022.54	0.9996
150.37	3.12	1548.81	0.9995
149.17	2.91	2884.83	0.9989
148.28	2.76	3027.11	0.9985

Thermal simulation

Enthalpic method (layer by layer)

The general model represents heat exchange during rotational moulding, in which approximation of thermal transfer is one dimensional. On the basis of this report, Tcharkhtchi et al. [14] used a more adapted method to describe phase change. This method makes it possible to use only one equation to describe thermal phenomenon in both two phases (liquid polymer and solid powder), and makes it possible, thus, to free from the calculation of boundary conditions on liquid/solid interface. It is named enthalpy method [15, 16]. If we leave the assumption that melting or crystallization does not occur at a constant temperature, which is more realistic for a particulate solid, enthalpy evolution according to temperature can be schematized as on Fig. 5. Considering two successive elementary sections (sections (i) and ($i + 1$)) in part in development. We observe that function $H_F = f(T)$ in melting case consists of three lines:

Fig. 5 Enthalpy evolution law according to temperature. Main parameters are: $T_{f,i}$ = initial fusion temperature of elementary layer (i); $T_{f,i+1}$ = initial fusion temperature of elementary layer ($i + 1$); L' = fusion latent heat and ρ = solid polymer density

(a) In field (1), as long as temperature did not reach melting point of layer (i) (that is to say $T < T_{f,i}$), we can write:

$$H_F(T) = \rho_{ps} C_{ps}(T - T_0) + H_0 \quad (3)$$

where, ρ_{ps} and C_{ps} are, respectively, solid polymer density and solid polymer specific heat. H_0 is enthalpy reference value at reference temperature ($T = T_0 = 298 \text{ K}$).

(b) In field (2), temperature reached melting point of layer i but not yet that of layer ($i + 1$) (either $T_{f,i} < T < T_{f,i+1}$). We consider a linear variation of enthalpy according to temperature:

$$H_F(T) = \frac{\rho_{ps} L'}{\Delta T} (T - T_{f,i}) + H_{F,i} \quad (4)$$

where, L' is fusion latent heat and $H_{F,i}$ i layer melting enthalpy value. ΔT is the difference between the temperature of the two layers (i and $i + 1$) and its expression is given by the following equation:

$$\Delta T = T_{f,i+1} - T_{f,i} \quad (5)$$

(c) In field (3), temperature reached melting point of layer ($i + 1$) (either $T_{f,i+1} < T$):

$$H_F(T) = \rho_{pl} C_{pl}(T - T_{f,i+1}) + H_{F,i+1} \quad (6)$$

where, ρ_{pl} and C_{pl} are, respectively, liquid polymer density and its specific heat. $H_{F,i+1}$ represents ($i + 1$) layer melting enthalpy value.

The differential equations that we could consider in numerical work are partial and of second order. In the literature we can list three adapted numerical methods [21–24]: explicit methods, Euler implicit and Crank–Nicholson method. On mathematical account of the simplicity, we adopted the second method [25]; the mould, the air and the studied polymer properties are given in Table 4.

With help of finite differences method, thermal transfer equations can be written with discretization in unidirectional space by order 1 Euler implicit scheme. Space field of length L is divided into N elements of size h_x and temperature is evaluated in each one of N nodes.

$$h_x = \frac{L}{N} \quad (7)$$

Temperature is evaluated in N nodes. The position of each node is described by:

$$x_i = ih_x, i \in [1, N] \quad (8)$$

Time is discretized as following:

$$t_k = k\Delta t, k \in [0, t_{\text{cycle}}] \quad (9)$$

So conduction (for example) can be discretized by:

Table 4 Main characteristics of mould, air and polyamide 11

Properties	Value	Unit
Polyamide 11 characteristics		
Heat of fusion ΔH_m at 100 % of crystallinity	226 ^c	J g ⁻¹
Crystallinity ratio, X_C	22.04 ^a	%
Density, ρ_{ps}	1,150 ^b	kg m ⁻³
Thermal conductivity, k_{ps}	0.19 ^d	W m ⁻¹ K ⁻¹
Specific heat C_{ps} at 25 °C	1800.6 ^a	J kg ⁻¹ K ⁻¹
Density, ρ_{pl}	1,010 ^b	kg m ⁻³
Thermal conductivity, k_{pl}	0.53 ^b	W m ⁻¹ K ⁻¹
Specific heat C_{pl} at 250 °C	2120.9 ^a	J kg ⁻¹ K ⁻¹
Air characteristics		
External air convection coefficient, h_{fa}	25 ^e	W m ⁻² K ⁻¹
Internal air convection coefficient, h_{pa}	05 ^e	W m ⁻² K ⁻¹
Air density, ρ_a	01 ^f	kg m ⁻³
Internal air specific heat, C_{pa}	1,010 ^f	J kg ⁻¹ K ⁻¹
Mould characteristics		
Mould density, ρ_{mo}	2,700 ^g	kg m ⁻³
Mould thermal conductivity, k_{mo}	218 ^h	W m ⁻¹ K ⁻¹
Mould specific heat, C_{mo}	950 ^h	J kg ⁻¹ K ⁻¹

^a Our experimental values

^b Technical data sheet

^c Ref. [26]

^d Ref. [27]

^e Ref. [28]

^f Ref. [29]

^g Ref. [30]

^h Ref. [31]

$$A \frac{T_{i+1}^k - 2T_i^k + T_{i-1}^k}{\Delta x^2} = \frac{T_i^k - T_i^{k-1}}{\Delta t} \quad \forall (i, k) \quad (10)$$

$$A = \frac{k_m}{\rho_m c_m} \quad (11)$$

Where k_m is mould thermal conductivity, ρ_m is mould density and c_m is mould specific heat.

$$-rT_{i-1}^k + (1 + 2r)T_i^k - rT_{i+1}^k = T_i^{k-1} \quad (12)$$

$$r = A \frac{\Delta t}{\Delta x^2} \quad (13)$$

Finally, discretization can be presented in matrix structure wherein each layer represents a matrix line. A non-empirical mathematical representation of thermal transfer in polymer could be written as:

Fig. 6 Temperature versus time (T/t) diagram of PA11 according to enthalpy method (layer to layer) and experimental one

$$(1 - \varepsilon)\rho_p \frac{\partial(C_p T)}{\partial t} + \Delta H = \frac{\partial}{\partial x} \left(k_p \frac{\partial T}{\partial x} \right) \quad (14)$$

ε is air fraction in polymer. It is, without any doubt, the most difficult parameter to evaluate. We will assume $\varepsilon = 0 \%$. ρ_p and C_p are, respectively, polymer density and polymer specific heat.

ΔH is polymer state change enthalpy. It takes following values:

- $\Delta H = +H_F$ with the passage of melting (for $T(x, t) = T_f$);
- $\Delta H = -H_C$ with the passage of crystallization (for $T(x, t) = T_C$);
- $\Delta H = 0$ everywhere else (for $T(x, t) \neq T_f$ and T_C).

Figure 6 shows the theoretical results obtained by our calculations and juxtaposed with those measured in experiments concerning PA11 part. We thus simulated the phase change appearing on the pseudo-stages obtained by the enthalpy method (layer to layer). The average relative error on temperature was found to be about 4.03 %.

Cooling simulation (Ozawa model with Duffo's approach)

In this case cooling can be described by the Ozawa formalism as presented in Eq. 2. The corresponding heat can be written by:

$$\delta T_C = \frac{\Delta H}{C_p} \frac{\partial X_t(x)}{\partial x} \delta x, \quad (15)$$

where, ΔH is the polymer state change enthalpy, C_p is the polymer heat capacity, δx is the distance variation (n layer in polymer) and X_t is the Crystallinity ratio that directly depends on cooling rate function $K(T)$.

It is calculated according to the Duffo's approach [32] which can be used in average cooling rate (rotational moulding case).

Duffo has proposed to use a polynomial of the fourth order to approximate $K(T)$ as following relationship:

$$\ln K(T) = A + BT + CT^2 + DT^3 + ET^4 \quad (16)$$

T is temperature, A , B , C , D and E is specific coefficients for each polymer. The determination of $K(T)$ requires the deduction of the experimental points starting from measurements obtained by DSC tests for the high temperatures and of the theoretical points, calculated according to the Duffo's approach, for the low temperatures.

The values of their coefficients are listed in Table 4 and 5.

Therefore, the Ozawa equation can be introduced in the heat transfer model by combining the two Eqs 14 and 15.

Figure 7 shows the plot of $K(T)$ as a function of temperature by applying experimental data and Duffo's approach in cooling rate ϕ of $10 \text{ }^\circ\text{C min}^{-1}$. We can observe that Duffo's approach reproduces the same experimental data; subsequently, it is possible to calculate the evolution of the crystallinity rate at all cooling rate, using Ozawa's equation to make a comparison with the experimental results.

Fig. 7 Evolution of $K(T)$ as a function of temperature, experimental data and Duffo's approach

Table 5 Polynomial Duffo coefficients in the case of rotational moulding PA6 grade at $\phi = 10 \text{ }^\circ\text{C min}^{-1}$

Polymer	A	B	C	D	E
PA11	34.5349160	0.5111350	-0.0147000	0.0001110	-0.0000002

Fig. 8 Temperature versus time (T/t) diagram of PA11 according to enthalpy method (layer to layer), Ozawa model and experimental one

Figure 8 shows the theoretical results obtained by our calculations and juxtaposed with those measured in experiments concerning PA11 part. We thus simulated the phase change appearing on the cooling pseudo-stage obtained by coupling the enthalpy method (layer to layer) with Ozawa model with Duffo approach. The average relative error on temperature was found to be about 2.03 %. In fact, with Ozawa model the crystallization pseudo-stage is well simulated than when we use only enthalpic method.

In addition to the significant and interesting results obtained by the enthalpy method, until a certain limit, we note that crystallization kinetic model application makes significant corrections and improvements as for crystallinity rate evolution.

Conclusions

This paper has presented a thermal model which permits to follow the local evolution of the temperature in various areas of rotational moulding of polyamides PA11. The developed model considers the thermal variations which are developed in rotational moulding pieces and takes melting and crystallization into account. The tested thermal model, by the enthalpic method, reproduces the temperature evolution in the polymer part taking into account the existence of the melting and crystallization pseudo-stages. However, the model in this case does not represent the real temperature evolution especially the crystallization pseudo-stage. The last is well represented by introducing the Ozawa equation, and the model became more efficient. The crystallization pseudo-stage was advantageously

restored by crystallization kinetic model (Ozawa), which takes into account two equations, namely the heat release equation and that of Ozawa's approach. Hence, the error between the experimental results and those obtained by the Ozawa combined with thermal model is reduced and the developed model in this case allows us to study the heat release during the crystallization process according to the crystallinity transformation rate.

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